TOSHIBA TLP864,TLP865

TOSHIBA PHOTO-INTERRUPTERS INFRARED LED + PHOTODARLINGTON TRANSISTOR

TLP864, TLP865

VCRS, COMPACT DISC PLAYERS
COPIERS, FAX MACHINES, PRINTERS
VENDING MACHINES, TICKET MACHINES
VARIOUS POSITION DETECTION SENSORS

The TLP864 and TLP865 photo-interrupters combine a GaAs infrared LED with a high-sensitivity Si photodarlington transistor. They exhibit a high current transfer ratio, can be driven using a low input current and are best suited for use in lowpower circuits.

- Small package
- TLP864 designed for direct mounting on printed circuit boards.

• Side mounting type : TLP865

• Gap : 3 mm

• Resolution : Slit width = 0.5 mm

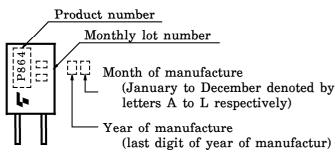
• High current transfer ratio : $I_C/I_F = 50\%$ (min)

at $I_F = 1 \, mA$

• Detector impermeable to visible light

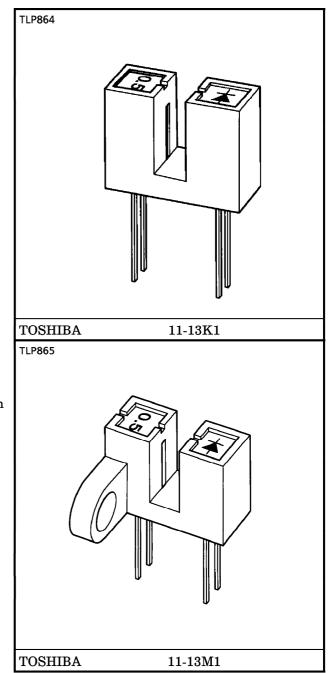
• Package material : Polycarbonate

MARKINGS



Letter color: Silver

ABBREVIATION	TYPE
P864	TLP864
P865	TLP865



Weight: 0.81 g (typ.) 0.82 g (typ.)

MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT	
	Forward Current	$I_{\mathbf{F}}$	50	mA	
LED	Forward Current Derating	ΔI _F /°C	-0.33	mA/°C	
	$(Ta > 25^{\circ}C)$	Δ1 F ¹ / C	-0.55	mA/C	
	Reverse Voltage	v_{R}	5	V	
	Collector-Emitter Voltage	v_{CEO}	30	V	
Q.	Emitter-Collector Voltage	v_{ECO}	5	V	
DETECTOR	Collector Power Dissipation	$P_{\mathbf{C}}$	75	mW	
TE	Collector Power Dissipation	ΔPC/°C		mW/°C	
Ē	Derating (Ta > 25 °C)	ΔFC/ C	-1	$ \mathbf{m}\mathbf{w} / \mathbf{C} $	
	Collector Current	$I_{\mathbf{C}}$	40	mA	
Operating Temperature Range		$T_{ m opr}$	-25~85	°C	
Sto	orage Temperature Range	$ m T_{stg}$	-40~100	°C	
So	ldering Temperature (5 s)	T_{sol}	260	$^{\circ}\mathrm{C}$	

RECOMMENDED OPERATING CONDITION

CHARACTERISTIC	SYMBOL	Min	Тур.	Max	UNIT
Supply Voltage	v_{CC}	_	5	16	V
Forward Current	$I_{\mathbf{F}}$	_	_	20	mA
Operating Temperature	Topr	-10	_	70	$^{\circ}\mathrm{C}$

OPTICAL AND ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
\Box	Forward Voltage	$ m V_{f F}$	$I_{\mathrm{F}} = 10 \mathrm{mA}$	1.00	1.15	1.30	V
LED	Reverse Current	$I_{ m R}$	$V_R = 5 V$	_	_	10	μ A
	Peak Emission Wavelength	$\lambda \mathbf{P}$	$I_{ m F}=10~{ m mA}$		940		nm
CTOR	Dark Current	I _D (I _{CEO})	$V_{ m CE} = 16 m V, I_{ m F} = 0$		1	0.25	μ A
DETE	Peak Sensitivity Wavelength	$\lambda_{\mathbf{P}}$			870	1	nm
Ω	Current Transfer Ratio	$I_{\mathbf{C}}/I_{\mathbf{F}}$	$V_{CE} = 2 V, I_F = 1 mA$	50		2000	%
LE	Collector-Emitter Saturation Voltage	V _{CE} (sat)	$I_{\mathrm{F}}=2\mathrm{mA},~I_{\mathrm{C}}=0.5\mathrm{mA}$	_	0.75	1	V
COUP	Rise Time	$t_{\mathbf{r}}$	$V_{CC} = 5 V$, $I_C = 1 mA$,	_	600	_	
Ľ	Fall Time	t_f	$R_{\rm L} = 1 { m k}\Omega$		500	_	μ s

PRECAUTIONS

The following points must be borne in mind.

- 1. Clean only the soldered part of the leads. Do not immerse the entire package in the cleaning solvent.
- 2. The package is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol and aliphatic hydrocarbons; however, with petrochemicals (such as benzene, toluene and acetone), alkalis, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate may crack, swell or melt. Please take this into account when chosing a packaging material by referring to the table below.

<Chemicals which should not be used with polycarbonate>

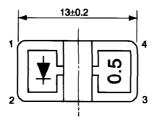
	PHENOMENON	CHEMICALS	
A	Staining and slight deterioration	• Nitric acid (diluted), hydrogen peroxide, chlorine	
В	Cracking, crazed or swelling	 Acetic acid (70% or more) Gasoline Methyl ethyl ketone, ethyl acetate, butyl acetate Ethyl methacrylate, ethyl ether, MEK Acetone, m-amino alcohol, carbon tetrachloride Carbon disulfide, trichloroethylene, cresol Thinners, oil of turpentine Triethanolamine, TCP, TBP 	
C	Melting { }: Used as solvent	 Concentrated sulfuric acid Benzene Styrene, acrylonitrile, vinyl acetate Ethylenediamine, diethylenediamine Chloroform, methyl chloride, tetrachloromethane, dioxane, 1, 2-dichloroethane 	
D	Decomposition	Ammonia water Other alkalis	

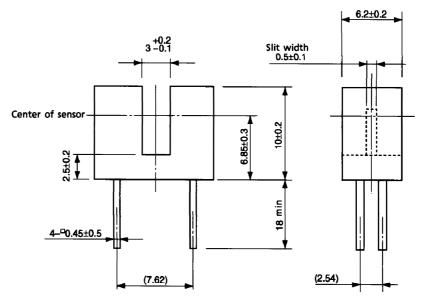
- 3. Mount the device on a level surface.
- 4. Screws should be tightened to a clamping torque of 0.59 N·m (on the TLP865).
- 5. Conversion efficiency falls over time due to the current which flows in the infrared LED. When designing a circuit, take into account this change in conversion efficiency over time. The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1:1.

$$\frac{I_{C}/I_{F}(t)}{I_{C}/I_{F}(0)} = \frac{P_{O}(t)}{P_{O}(0)}$$

PACKAGE DIMENSIONS 11-13K1

Unit: mm

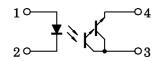




(): Reference value

Weight: 0.81 g (typ.)

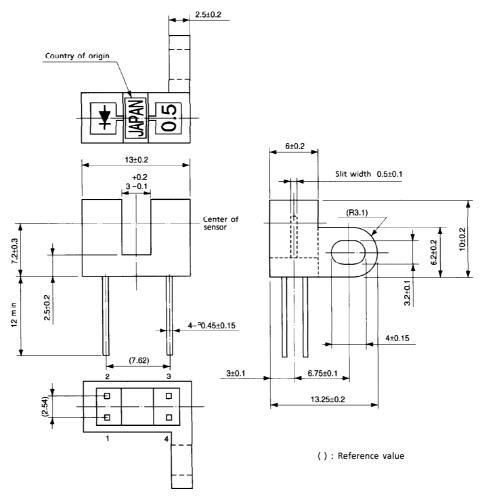
PIN CONNECTION



- 1. Anode
- 2. Cathode
- 3. Collector
- 4. Emitter

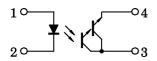
PACKAGE DIMENSIONS 11-13M1

Unit: mm

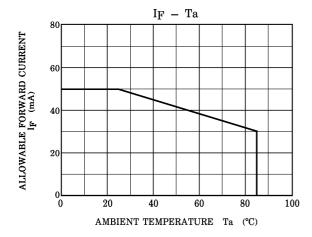


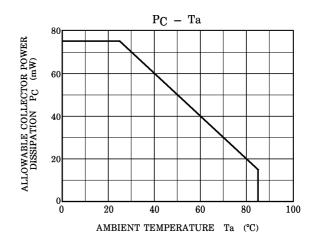
Weight: 0.82 g (typ.)

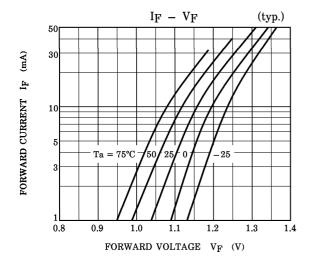
PIN CONNECTION

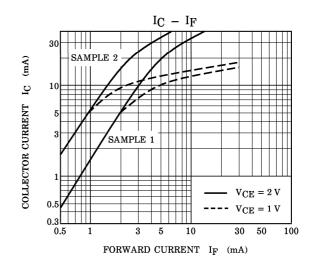


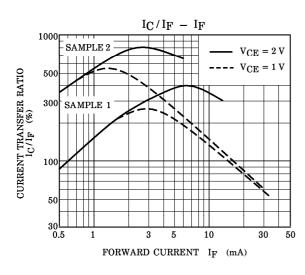
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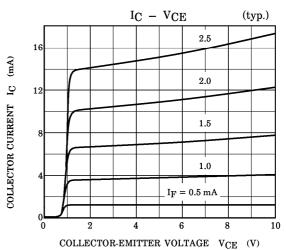


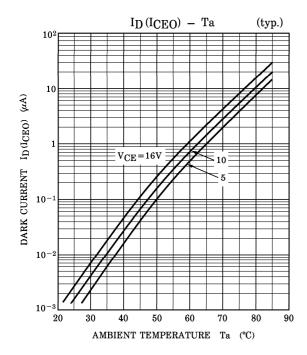


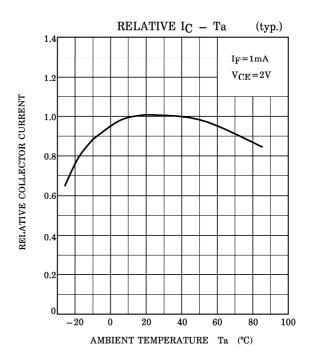


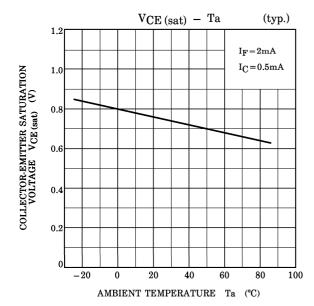


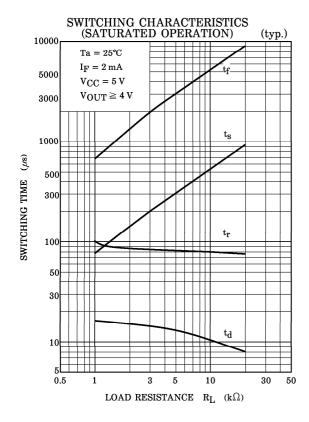


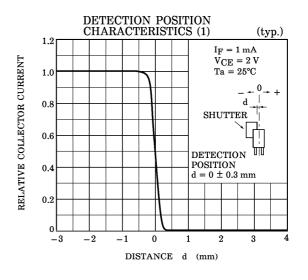


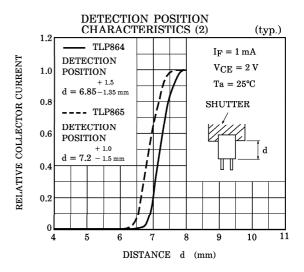




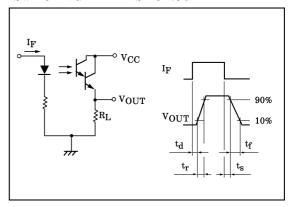








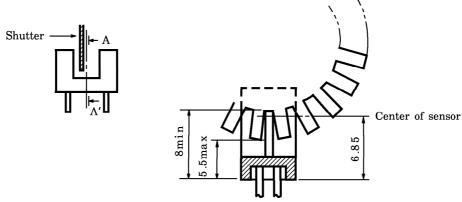
SWITCHING TIME TEST CIRCUIT



RELATIVE POSITIONING OF SHUTTER AND DEVICE

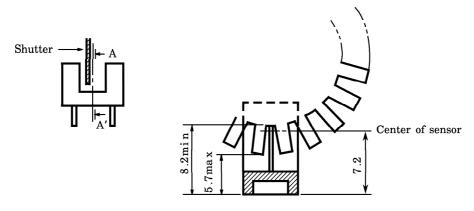
For normal operation position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.

TLP864 Unit in mm



Cross section between A and A'

TLP865



Cross section between A and A'

RESTRICTIONS ON PRODUCT USE

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